1. INTRODUCTION

Getting optimum performance with high-performance converters is not a trivial task. Good system grounding techniques, power supply filtering, careful board layout, and control of system clocks and high-speed digital signals is of utmost importance. We will cover these and other subjects in this application note in order to allow your design to get the best performance from the CS5531/2/3/4 converters.

The CS5531/2/3/4 family of Delta-Sigma converters are some of the lowest-noise DC measurement devices in the market. These devices are suitable for many applications where high-resolution measurements of very small DC voltages are required, such as weigh scales, pressure transducers, and thermocouples. With a built in, low-noise, programmable gain amplifier, the full-scale input range can be as low as 39.0625 mV DC in unipolar mode with a 2.5 V or 5 V VREF. As will be demonstrated in this application note, the input scale can be reduced even further, allowing very small differential inputs to be measured to a high degree of resolution. For example, as explained in this document, a 10 mV full-scale unipolar input can be measured to 0.596 nV per least-significant bit with the 24-bit devices. Obviously the output will contain noise, but with software averaging, that noise can be resolved to an impressive number of noise-free bits.

2. THE IMPORTANCE OF A GOOD GROUND PLANE

In order to reduce board costs, some designs may attempt to use single- or double-sided boards and fill unrouted areas with a ground plane. Please be aware that this is not an effective practice in a high-performance analog-to-digital conversion circuit. A low-noise, low-impedance, uninterrupted ground plane is extremely important in order to get optimum performance from the ADC. However, filling unused areas around the input traces with copper and connecting that copper to the ground plane does have some additional advantages regarding Faraday shielding.

The ground plane is the point of reference for many signals on the board. The extremely low-level analog input signals are very susceptible to corruption from noise voltage transients on the ground plane. Since the ground plane is used to conduct supply and return currents for high-speed signals, it is possible to introduce unwanted noise voltage drops across the ground plane.

Consider the best possible PCB layout for the simple schematic shown in Figure 1 below.

Figure 1. Analog Input Circuit for a CS5534 ADC
As illustrated in Figure 2, if a high-speed signal return path or power supply return path flows through the ground plane in such a way that introduces a noise voltage drop between the point where two capacitors, one on AIN+ and one on AIN-, connect to the ground plane, a differential noise voltage will be inadvertently applied to the ADC input through those capacitors.

This does not necessarily mean that, in order to avoid voltage drops across the plane, one should avoid using a common ground plane for both digital and analog circuitry. The debate about whether digital ground and analog ground should be separated has gone on for years but one thing remains indisputable – the digital ground (DGND) pin and any other pin on the ADC that connects to analog ground must be tied together at the ADC via a very low-impedance path. This includes bypass capacitors on the power pins and anti-aliasing and filter capacitors on the AIN and VREF pins. If separate DGND and analog ground (AGND) planes are used, they must be tied together beneath the ADC. Also, take great care to prevent clock or high-speed digital signal traces from crossing splits in the ground plane (or splits in an adjacent power plane). The problem with split or non-continuous planes is that high-speed return currents tend to return to the source in a path that is as close to the active trace as possible. However, discontinuities in the adjacent ground or power plane force the currents to deviate from that path. This deviation results in "antenna" loops that radiate high-frequency energy as illustrated in Figure 3. Once these signals are radiated it is very difficult to prevent them from being picked up by the sensitive analog inputs.
It is important to note that the CS5531/2/3/4 devices do not have an AGND pin. The common-mode reference for the analog inputs is VA- (the die substrate). In single-supply configurations it is important that VA- be connected to the DGND pin through a low-impedance ground plane. In dual-supply configurations the bypass capacitors on VA- and VA+ should be connected to the same ground as the DGND pin through low-ESR (effective series resistance) bypass capacitors. The reason for this is that any noise differential between these pins will result in noise from the digital core ground (DGND pin) getting into the internal analog circuitry through the level shifters and parasitic capacitance on the die. Also, any noise differential between the VA- pin and the anti-aliasing capacitors on the analog inputs will result in common-mode noise being directly coupled to the inputs. Although the ADC has an excellent common-mode rejection ratio (CMRR) at DC and low frequencies, the higher the frequency of the common mode noise, the more likely it is that it will be sampled by the ADC and aliased into the pass band. This is especially true of noise from switch-mode power supplies.

In general, the ADC should be located such that any heavy dynamic currents flowing in the ground plane are kept away from the converter. This may require that the converter be located on the PCB as far from the power connections as possible. Furthermore, digital IO ports that leave the PCB should not be located near the ADC. The transient currents these ports often must provide to charge parasitic capacitance on the cabling can create significant noise differentials in the ground plane. If these guidelines are followed it may not be necessary to use separate analog and digital ground planes. Therefore the problem of high-speed signals crossing splits in the plane is avoided.

3. DECOUPLING (BYPASS) CAPACITORS

As noted previously, the choice and placement of capacitors for power supply decoupling is very important. The supply currents to mixed-signal devices are dynamic, not steady-state DC. If this dynamic current was supplied only by a power source located away from the ADC, very large fluctuations in the voltages at the power pins of the device would be seen as a result of the series impedances between the device and the power source. Therefore, capacitors are required at the power pins of the device to act as a reservoir of charge for these dynamic currents. For this reason, these capacitors must be located as close as physically possible to the power pins in order to minimize the series impedance between the power pins and the capacitors. The bypass capacitors for VA+ and VA- should be between these power pins instead of from each pin to ground since they provide a reservoir of charge between the

![Image of Antenna Loop Caused by Ground or Power Plane Splits](image_url)

Figure 3. Antenna Loop Caused by Ground or Power Plane Splits
power pins. The practice of placing the bypass capacitors on the opposite side of the circuit board and connecting them to the power pins through vias should be avoided. The inductance of the via degrades the performance of the capacitor significantly at high frequencies. Also, the capacitor should be placed between the ADC power pins and the via(s) connecting to the power source. In other words, if the power pins are connected by vias to power or ground planes, the capacitor should be between the power pins and the vias as illustrated by C3 in Figure 2.

It should also be noted that placement of C4, the 22 nF low-pass filter capacitor, is very important. In Figure 2 this component is placed on the opposite side of the PCB and connected with vias. This is acceptable and preferred over crowding the top side of the PCB with the VA+ bypass capacitor. In fact, traces to the C2 pin and the VA+ pin should be kept away from each other to avoid leakage currents in high-humidity conditions.

It can be advantageous to have some impedance between the power pin bypass capacitors and the power source. For example, when using the same power source for VA+ and VD+, it is recommended that a 10-ohm resistor is placed between the VD+ pin and the power source. This is possible with CS553x devices because the VD+ pin requires very little average current and therefore only a small voltage drop occurs. Since the bypass capacitor on the VD+ pin has a much lower source impedance than the 10-ohm resistor to the power source, the dynamic current required by VD+ comes almost exclusively from the capacitor. This prevents digital noise from the VD+ pin from being introduced on the VA+ pin. The same applies for VD- and VA- in bipolar power supply configurations.

The bypass capacitor also has a second purpose – to act as a power supply noise filter device. All power sources contribute some amount of noise. It is very important to eliminate as much noise as possible from the VA+ and VA- supplies. One of the surest ways to degrade the performance of a high-resolution ADC is by powering it with a noisy power source. Like CMRR, the power supply rejection ratio (PSRR) is good at low frequencies such as 50 or 60 Hz. However, the PSRR decreases as the frequency increases. The higher the noise frequency, the more likely it is that it will degrade the performance of the ADC. Therefore, it is wise to provide some means of filtering as much noise as possible from the power source at the VA+ and VA- pins. One approach is to use inductors or ferrite beads to introduce an impedance at higher frequencies only. However, care should be taken when using inductors in series with the power source because, in conjunction with the bypass capacitors, they can resonate. This will result in a "ringing" effect whenever a transient edge excites the LC circuit at its resonate frequency. This can be minimized by including a small series resistance to damp the resonance of the LC circuit by lowering its Q factor. Often the resistance of the coil is adequate if the value of the inductance is sufficiently high.

If they are carefully chosen, ferrite beads can also be an effective means of reducing power supply noise. Unlike an inductor, ferrite beads dissipate high-frequency energy rather than simply introducing a high impedance to it. Ferrite beads will not resonate with the bypass capacitors. While a ferrite bead does have inductance, it can be thought of as a frequency-dependent resistor and therefore has a very low Q factor. In selecting a ferrite bead to filter the power supply, several parameters should be considered. First, the DC bias current characteristics must be determined. Ferrite beads have a current rating which determines when the bead saturates. When a ferrite bead saturates, its impedance drops off rapidly causing it to be ineffective at reducing high-frequency noise. Saturation is partially a factor of the physical size of the bead; therefore, a larger ferrite bead may be more effective with higher currents. The second characteristic that must be considered in selecting a ferrite bead is its effective frequency range. This is determined by the composition of the ferrite alloy. For power supply filtering, the lowest-frequency compositions should be the most effective. For example, the Fair-Rite® P/N 2773021447 surface mount bead has an impedance of 28 ohms at 1 MHz (see Figure 4). Many beads, especially surface mount beads, offer very little if any impedance at this low frequency. Since much of switch-mode power supply harmonics will be in this frequency range, this component would be an effective means of attenuating much of that noise. This impedance, in combination with the low impedance of an X7R ceramic capacitor will attenuate a large portion of the power supply noise with almost no DC voltage drop. In a bipolar supply configuration, these capacitors should be between each supply pin and ground as well as the capacitor from VA+ to VA- as mentioned earlier.
4. CONTROLLING DIGITAL SIGNAL NOISE

The ADC is a mixed-signal device and has digital as well as analog pins. Therefore, in most applications, there are relatively high-energy digital signals in close proximity to very low-level analog signals - especially near the ADC itself. Thus, great caution should be used to assure that the digital signals do not corrupt the low-level analog signals. Two methods that have already been mentioned should be used – avoiding high-speed signals crossing splits in the power or ground planes and avoiding locating digital ports that leave the board near the ADC.

Whether a crystal is used with the internal crystal oscillator or an external oscillator is used, the routing of the clock traces to the ADC should be carefully placed. Again, avoid allowing the clock signals to cross a split in the power and ground planes and route the clock as far from AIN and VREF signals as possible.

External clock oscillators and microcontroller or microprocessor serial bus signals often have much faster edges than are required by the ADC. These fast edges along with circuit board parasitic capacitance and inductance often create reflections and high-energy harmonics into the hundreds of megahertz. One effective way to minimize these reflections and harmonics is to put a damping resistor in series with the trace as close to the source pin as possible. For example, the SCLK and SDI signals from a microprocessor or microcontroller could have 20- to 50-ohm series resistors at the microprocessor pins and the SDO signal could likewise have a 20- to 50-ohm resistor at the ADC SDO pin. The actual value of the resistor will depend on the board parasitics and trace lengths and could be determined by simulation software (such as HyperLynx® from Mentor Graphics®) or it could be determined empirically after the board is built by observing the signal with a low capacitance oscilloscope probe. Using the probe, the smallest resistor value that eliminates overshoot and undershoot and other reflection induced artifacts should be used. Obviously too large a resistor value will result in excessive slewing of the digital signals and may compromise the noise immunity of the digital interface. Generally the resistor value should be 50 ohms or less.

5. OPTIMIZING THE INPUT SPAN

The CS5531/32/33/34 delta-sigma converters have a built-in digital filter and calibration engine. The delta-sigma modulator generates a single-bit bitstream of 307,200 bits per second (assuming a 4.9152 MHz crystal or oscillator and FRS = 0) which is the input to the digital filter. From this bitstream the digital filter creates a parallel digital word representative of the analog input voltage. The calibration engine takes this digital value (which has more resolution than the output word), adds the offset correction from that channel’s offset calibration register, and then multiplies that result by the contents of the gain calibration register for that channel. This result is then truncated to
16 (CS5531/3) or 24 (CS5532/4) bits and placed in the output register. At reset the value in all of the offset registers is zero (0x00000000) and the gain correction registers contain a gain multiplier of one (0x01000000). If the offset and gain corrections are not required by an application, as is often the case in ratiometric applications, the gain calibration register can be used to change the full-scale input span of the ADC. For example, if the channel setup is programmed for a gain of 64x in unipolar mode, the full-scale input span with a 2.5 V DC reference (VRS = 1) or 5 V DC reference (VRS = 0) would be 39.0625 mV. However, if it is desired to have the full-scale range be 10 mV, this could be achieved by writing a value of 3.90625 (0x03E80000) into the gain calibration register for that channel. Since the internal resolution of the filter's output is several bits greater than the output word resolution, multiplying by 3.90625 results in almost two bits of that internal resolution being utilized in the output that would have otherwise been truncated. This in itself does not improve the noise-free resolution of the output, but with adequate software averaging of this output, additional noise-free bits are possible as long as the noise distribution is Gaussian. It should be pointed out that if this method is used, the offset register should be zero. Otherwise an offset calibration should be performed after the gain register is written because the offset value will also be multiplied by the gain register value.

6. DC MEASUREMENT AVERAGING

The above section referred to averaging the ADC readings in software in order to obtain additional noise-free bits of resolution. In DC measurement, where the input seldom changes, this can be a simple average. Otherwise a running average or a more adaptive, weighted average that detects changes in the DC input above a certain threshold can be used. Which method is used and what sample rate is used will depend on the system requirements for the DC reading. How much latency can be tolerated between an input change and the completely settled result needs to be determined before an averaging algorithm is chosen. The purpose of this explanation is simply to suggest a few methods that could be implemented, especially when noise-free resolution is the main concern.

Before a software averaging algorithm is chosen, the sample rate for the converter should be selected. For measuring a steady-state DC input, the advantages of using a low sample rate such as 7.5 Sps should be noted. To remove as much of the noise as possible, lower sample rates take better advantage of the on-chip digital filter. However, this conversion rate is based on the CS553x continuous conversion mode where complete settling only occurs after four conversions. If the input multiplexer is used, single conversion mode is recommended because each conversion is fully settled (in essence the part converts the input four times before giving an output word). The slowest output rate in this case is approximately 1.8 Sps. Therefore in many applications where the inputs are being multiplexed it may be desirable to use a higher conversion rate and average each input in software to remove some of the noise. There is an advantage in using conversion rates of 60 Sps (50 Sps when FRS = 1) or lower because power line frequency rejection is excellent at these rates due to a notch in the sinc3 filter at this frequency.

Once the conversion rate is determined, a software algorithm for averaging the readings for each channel to remove more noise may be useful. A simple running average of eight is where only the last eight conversions are added then divided by eight giving each conversion equal weight. This average fully settles in eight conversions since all conversion results before the last eight are discarded. Simple exponential averaging is defined as each new reading being a fractional part of the averaged result. For example, if the new reading is multiplied by 0.125 and then added to the previous average multiplied by 0.875 then the new reading becomes 1/8 of the average. In this algorithm the most-recent value has the highest weight with older conversions diminishing in weight exponentially. However, this exponential averaging has the highest latency because it takes many conversions for a single reading to be completely flushed from the average, especially when a step change occurs on the input. In fact, a full-scale change on a 24-bit converter would take 83 conversions for the average to settle to 16 bits of accuracy. Another algorithm is the adaptive exponential average. In this case, the weight of the new ADC reading depends on the difference between it and the previous average. Here a threshold needs to be determined that indicates that a step change has occurred on the input. This threshold should be above normal peak-to-peak system noise in order that noise below the threshold can be averaged out by the normal exponential average. However, if the new reading is beyond the normal peak-to-peak noise threshold, the new reading supersedes the average so that the step is made in a single conversion. This algorithm has numerous possibilities if multiple thresholds are specified with each step
magnitude resulting in higher weights for the new reading. See Figure 5 to compare the step responses of these algorithms.

![Averaging Algorithm Responses](image)

**Figure 5. Algorithm Step Response Comparison**

Figures 5a, 5b, 5c, and 5d illustrate the typical peak-to-peak noise performance of a CS5532AS with a gain of 64 and word rate of 60 Sps. Figure 5a shows the noise performance without software filtering and the other three plots illustrate the effects of applying different software filtering algorithms. Without any software filtering, the peak-to-peak noise is 64 codes or 6 bits, which is consistent with the data sheet’s specification of 18 noise-free bits. With the simple running average of 8 algorithm, approximately one more bit of noise-free performance can be gained (peak-to-peak noise of 35 codes), while the simple exponential average of 8 gives slightly better improvement (27 codes peak-to-peak). The simple exponential average of 64 results in approximately 8 codes peak-to-peak or a noise-free resolution improvement of 3 bits.
Figure 5a. Noise Performance – No Software Filtering

Figure 5b. Noise Performance – Simple Running Average of 8

Figure 5c. Noise Performance – Simple Exponential Average of 8

Figure 5d. Noise Performance – Simple Exponential Average of 64
In most applications the simple exponential average of 64 would result in excessive output settling latency, so an adaptive algorithm could be used to allow a quicker response to step changes in the input. The following code segment uses two thresholds to accomplish a quick response while improving noise-free performance by 3 bits for a steady state input.

while(1)
{
    NewValue = ReadADC();
    Difference = abs ( NewValue – Average );
    if ( Difference > 256 )   /* No software average for large steps */
        Average = NewValue;
    else if ( Difference > 64 )  /* Exponential average of 8 for medium step size */
        Average = Average * 0.875 + NewValue * 0.125;
    else     /* Exp. ave. of 64 for steady state noise reduction */
        Average = Average * 0.984375 + NewValue * 0.015625;
    /* Scale the value for readout after averaging */
    DisplayValue = ScaleValue( Average );
    UpdateDisplay( DisplayValue );
}

Figure 6. Adaptive Algorithm Code Example

In this code, if any step in ADC output over 8 bits is detected, the average is updated to the new value without any software filtering. If continuous conversion mode is used there will still be a four-conversion latency. However, this will minimize overshoot and if a faster word rate is used, the latency should be acceptable for most applications. If the step size is between 64 and 256, a simple exponential average of 8 is used allowing reasonably fast settling as the final value is approached. Once the new value is within 64 bits of the average value the algorithm switches to a simple exponential average of 64. As long as the input remains within a ±64 LSB range, the simple average of 64 is maintained, resulting in 3 additional noise-free bits of performance for steady-state inputs. For slower microcontrollers which do not have floating point units, left and right shifts on integer values and subtraction and addition can be used as long as the filter coefficients are powers of two.

7. CONCLUSION

As this application note explains, there are many factors that determine the success of a high-resolution ADC implementation. The Cirrus CS5531/32/33/34 family of converters are some of the quietest converters on the market and if careful mixed-signal design practices are observed, incredibly accurate high-resolution measurements of very low-level DC signals can be achieved.

As always, Cirrus Logic applications support offers schematic and PCB layout review to our customers. In many cases less-than-optimum designs or layout errors can be corrected before the PCB is produced.
8. REVISION HISTORY

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<tr>
<th>Release</th>
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<th>Changes</th>
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<tbody>
<tr>
<td>REV1</td>
<td>SEP 2006</td>
<td>Initial Release</td>
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